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Adhesiveless Material Layer Up for 1L Flex circuits

Polyimide	Coverlay	25	1mil CVL
Adhesive		25	
Copper trace	Base material	18	1OZ Copper + 1mil PI
Polyimide		25	
		93	

Final thickness: **0.93+/-0.03mm**

Option A

Polyimide	Coverlay	25	1mil CVL
Adhesive		25	
Copper trace	Base material	18	1/2OZ copper + 1mil PI
Polyimide		25	
		93	um

Final thickness: **0.09+/-0.03mm**

Option B

Polyimide	Coverlay	25	1mil CVL
Adhesive		25	
Copper trace	Base material	18	1/2OZ copper + 1/2mil PI
Polyimide		12.5	
		80.5	um

Final thickness: **0.08+/-0.03mm**

Option C

Polyimide	Coverlay	12.5	1/2mil CVL
Adhesive		15	
Copper trace	Base material	18	1/2OZ copper + 1/2mil PI
Polyimide		12.5	
		58	um

Final thickness: **0.06+/-0.03mm**

Option D